Supporting Information

Solution-based Synthesis of Wafer-Scale Epitaxial BiVO₄ Thin Films Exhibiting High Structural and Optoelectronic Quality

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Figure S1. Contact angle of $BiVO_4$ precursor solution on YSZ substrate. Contact angle image acquired (a) on cleaned YSZ and (b) on cleaned and pre-annealed (500 °C for 30 min) YSZ.



Figure S2. X-ray diffraction characterization of epi- and poly-BiVO₄/YSZ. (a) Grazing-incidence XRD (GI-XRD) scans of poly-BiVO₄/YSZ and epi-BiVO₄/YSZ. Several peaks can be seen between 53° and 58° in the GI-XRD pattern of epi-BiVO₄/YSZ. These peaks do not stem from the polycrystalline BiVO₄ domains, but instead from the YSZ (113) planes ($2\theta = 59.48^{\circ}$) as well as from the BiVO₄ (061) and (261) planes ($2\theta = 53.23^{\circ}$ and 53.32°, respectively), of which the incline angles make them coincidently detectable in GI-XRD geometry. (b) Pseudo-Voigt fit of the interference oscillations around the BiVO₄ (040) peak in the θ -2 θ high-resolution XRD (HR-XRD) scan of epi-BiVO₄/YSZ for film thickness determination. (c) θ -2 θ HR-XRD scan of epi-BiVO₄/YSZ with the stars indicating diffraction peaks resulting from YSZ substrate. (d) Rocking curves of epi-BiVO₄/YSZ with FWHMs ranging from 0.035° to 0.05° recorded around the BiVO₄ (040) peak at 2 θ = 30.55° at different measurements positions across the 2" diameter wafer.



Figure S3. Band gap analysis of epi-BiVO₄/YSZ and poly-BiVO₄/fused silica. Tauc plots of the PDS absorption data to determine the indirect band gap (black) and the direct transition (blue) of (a) epi-BiVO₄/YSZ and (b) poly-BiVO₄/fused silica.



Figure S4. Optical constants of the BiVO₄ thin films. (a) The refractive index, *n* (top) the extinction coefficient, κ (bottom), as well as (b) the real part ε_1 (top) and the imaginary part ε_2 (bottom) of the dielectric function of epi- and poly-BiVO₄/YSZ, and of poly-BiVO₄/fused silica obtained by fitting of spectroscopic ellipsometry data.

We note that two different unit cell definitions, which differ in the chosen symmetry and axis assignment, are commonly used for ms-BiVO₄. The first convention is to choose the *b*-axis of the unit cell as the unique axis with the space group $C_{2/c}$, and the second is to define the *c*-axis as the unique axis with the space group $I_{2/b}$ (Fig. S1). We will use the first convention, in which the long *b*-axis is given by *b* = 11.697 Å, while *a* = 7.247 Å, and *c* = 5.090 Å, with β = 134.225°¹.



Figure S5. Crystal lattice of monoclinic scheelite BiVO4. Two different conventionally used unit cells are indicated by black lines.



Figure S6. Raman spectra of epi- and poly-BiVO₄/YSZ. The spectra of epi- and poly-BiVO₄/YSZ thin films confirm the monoclinic scheelite BiVO₄ phase, characterized by the (VO4)³⁻ v₁ symmetric stretching mode at ~826.5 cm⁻¹, the v₂ bending modes of the VO₄ units at ~324.4 cm⁻¹ and 367.6 cm⁻¹, and the external mode at ~211.5 cm⁻¹ comparable to the findings of Frost *et al.*². The strong peak at ~607.8 cm⁻¹ can be assigned to the characteristic YSZ F₂₉ peak³.



Figure S7. X-ray photoelectron spectroscopy scans of poly- and epi-BiVO₄/YSZ. (a) Survey spectra, (b) and (d) Bi 4f, and (c) and (e) O 1s, V 2p high-resolution spectra. The XPS measurements confirm the growth of closed and pure BiVO₄ films on YSZ with no detectable impurities and no exposed YSZ substrate. The survey and high-resolution spectra of the epi-BiVO₄/YSZ are comparable to those of poly-BiVO₄/fused silica in previous studies⁴. The Bi:V ratio for both the poly- and epi-BiVO₄/YSZ is ~1.7, indicating a Bi-rich surface as reported in literature for spin-coated polycrystalline BiVO₄⁴ and no significant change in the surface stoichiometry after the solid-state transformation to epitaxial BiVO₄. The Bi-rich surface points to the devolatilization of V during the spin-coating synthesis at higher temperatures in air as previously reported by Lamers *et al.*⁵.



Figure S8. Energy-dispersive X-ray spectrum of epitaxial $BiVO_4/YSZ$ with deconvoluted peaks of the individual elements highlighted in color, and the fitted background shown in grey.



Figure S9. (a) High-resolution XRD θ -2 θ scans of epitaxial BiVO₄ grown on three different YSZ wafers on different days. (b) Rocking curves of the three different wafers recorded around the BiVO₄ (040) peak at 2 θ = 30.55°. The corresponding values for the FWHM are given in the plot legend.



Figure S10. (a) Photograph of an epitaxial BiVO₄/YSZ wafer and (b) the thickness of the BiVO₄ layer measured along a straight line through the wafer center and obtained by fitting ellipsometry data. Commercial focusing optics to obtain a spot size of 200 μ m were used for acquiring the ellipsometry data.



Figure S11. Atomic lattice models of $BiVO_4/YSZ$. (a) $BiVO_4$ (010) on YSZ (001) in side view, and (b) and (c) the in-plane atomic arrangement in top view of $BiVO_4$ [001] || YSZ [100], $BiVO_4$ [001] || YSZ [010] and of YSZ (001), respectively. Bi atoms are indicated in purple, V atoms in blue, O atoms in grey and Zr atoms in green.

(a) X-ray incident along YSZ [100] direction



(b) X-ray incident along YSZ [110] direction



Models for BiVO₄[001] || YSZ[100]:





(c) X-ray incident along YSZ [010] direction





Figure S12. 2D reciprocal space maps (RSMs) of epi-BiVO₄/YSZ. X-ray incidence along the YSZ (a) [100], (b) [110], and (c) [010] direction. The corresponding RSMs predicted by the model for BiVO₄ [001] \parallel YSZ [100] are shown in the right column.



Figure S13. AFM topography images of one layer of spin-coated BiVO₄ on pre-treated YSZ after different pyrolysis conditions. AFM image (a) after the pyrolysis directly performed at 650 °C for 10 min and (b) after the pyrolysis performed at the conditions optimized for polycrystalline material (500 °C for 10 min).



Figure S14. Pole figures of poly-BiVO₄ on different substrates. Pole figures of (a, c, e) poly-BiVO₄/YSZ and (b, d, f) poly-BiVO₄/fused silica.



Figure S15. Temperature behavior inside the muffle furnace during the solid-state transformation from poly- to epi-BiVO₄/YSZ. Actual temperature (blue) on YSZ inside the muffle furnace and actual temperature of the oven (red) over time with a programmed temperature setpoint of 650 °C (black). At t = 0 min the oven door was opened and the sample was placed inside. After 10 min the sample was taken out (vertical dashed lines). After placing the YSZ substrate inside the furnace preheated to 650 °C at *t* = 0, two different heating ramps can be distinguished in the first 100 s. For the first ~15 s, the highest thermal ramp rate of ~20 °C/s occurs up to ~325 °C. Within the following ~85 s, 90 % of the total temperature increase is reached with a heating ramp of ~3 °C/s. The remaining time the YSZ substrate heats up with significantly decreasing rate until it is taken out of the oven after 10 min.



Figure S16. AFM images of BiVO₄/YSZ after annealing in a silicon housing for 10 min at (a) 625 °C and (b) at 675 °C.

References

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